



**Product data sheet** 

## 1. Product profile

### 1.1 General description

Hyperfast, epitaxial rectifier diode in a SOD113 (2-lead TO-220F) plastic package.

Low thermal resistance

Isolated package

### 1.2 Features

- Extremely fast switching
- Low reverse recovery current
- Reduces switching loss in associated MOSFET

### 1.3 Applications

- Half-bridge or full-bridge switched-mode
   Continuous Current Mode (CCM) Power
   Factor Correction (PFC)
- Half-bridge lighting ballasts

### 1.4 Quick reference data



# 2. Pinning information

Table 1.	Pinning		
Pin	Description	Simplified outline	Symbol
1	cathode (k)		
2	anode (a)	mb	k ————————————————————————————————————
mb	mounting base; isolated	SOD113 (2-lead TO-220	)F)

# 3. Ordering information

Table 2.         Ordering information						
Type number	Package	Package				
	Name	Description	Version			
BYC20X-600	TO-220F	plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 2-lead TO-220 'full pack'	SOD113			

## 4. Limiting values

#### Table 3.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

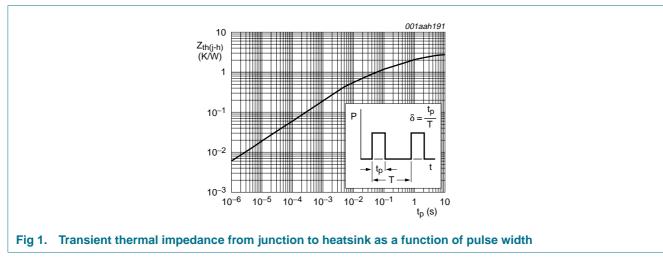
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>RRM</sub>	repetitive peak reverse voltage		-	600	V
V <sub>RWM</sub>	crest working reverse voltage		-	600	V
V <sub>R</sub>	reverse voltage	square waveform; $\delta$ = 1.0; $T_h \leq 100~^\circ C$	-	500	V
I <sub>F(AV)</sub>	average forward current	square waveform; $\delta$ = 0.5; $T_h$ $\leq$ 25 $^\circ C$	-	20	А
I <sub>FRM</sub>	repetitive peak forward current	square waveform; $\delta$ = 0.5; T_h $\leq$ 25 °C; $t_p$ = 25 $\mu s$	-	40	А
I <sub>FSM</sub>	non-repetitive peak forward current	t = 10 ms; sinusoidal waveform	-	250	А
		t = 8.3 ms; sinusoidal waveform	-	274	А
T <sub>stg</sub>	storage temperature		-40	+150	°C
Ti	junction temperature		-	150	°C

2 of 9

**Rectifier diode, hyperfast** 

#### **Thermal characteristics** 5.

Table 4.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-h)</sub>	thermal resistance from junction to heatsink	with heatsink compound; see Figure 1	-	-	2.6	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	-	55	-	K/W



#### **Isolation characteristics** 6.

#### Isolation limiting values and characteristics Table 5.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>isol(RMS)</sub>	RMS isolation voltage	from all terminals to external heatsink; f = 50 Hz to 60 Hz; sinusoidal waveform; relative humidity $\leq$ 65 %; clean and dust free	-	-	2500	V
C <sub>isol</sub>	isolation capacitance	from pin 1 (cathode) to external heatsink; f = 1 MHz	-	10	-	pF

 $T_{\rm b} = 25 \,^{\circ}C$  unless otherwise specified

Rectifier diode, hyperfast

## 7. Characteristics

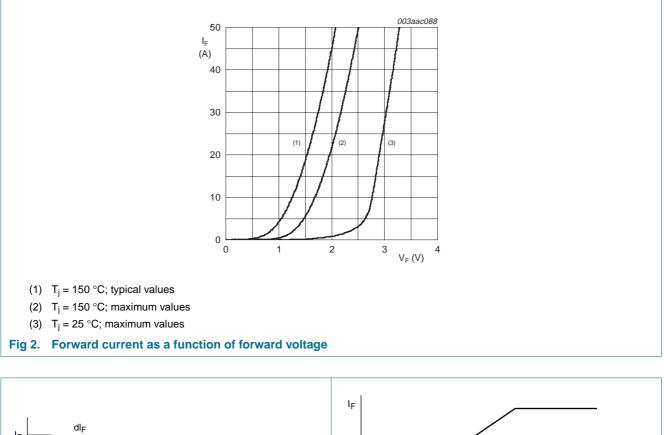
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V <sub>F</sub>	forward voltage	$I_F = 20 \text{ A}; T_j = 150 \text{ °C}; \text{ see } \frac{\text{Figure 2}}{1000 \text{ C}}$	-	1.54	1.97	V
		$I_F = 40 \text{ A}; T_j = 150 \text{ °C}; \text{ see } \frac{\text{Figure 2}}{\text{Figure 2}}$	-	1.95	2.34	V
		I <sub>F</sub> = 20 A; see <u>Figure 2</u>	-	1.89	2.9	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 600 V	-	16	200	μΑ
		$V_R$ = 500 V; T <sub>j</sub> = 100 °C	-	1.6	3.0	mA
Dynamic o	haracteristics					
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A to } V_R = 30 \text{ V}; \text{ d}_F/\text{d}t = 50 \text{ A}/\mu\text{s};$ see Figure 3	-	35	55	ns
		$I_F$ = 20 A to $V_R$ = 400 V; $dI_F/dt$ = 500 A/µs; see Figure 3				
		T <sub>j</sub> = 25 °C	-	19	-	ns
		T <sub>j</sub> = 100 °C	-	32	40	ns
I <sub>RM</sub>	peak reverse recovery current	$I_F$ = 20 A to $V_R$ = 400 V; $T_j$ = 125 °C; see <u>Figure 3</u>				
		$dI_F/dt = 50 A/\mu s$	-	3.0	7.5	А
		$dI_F/dt = 500 \text{ A}/\mu\text{s}$	-	9.5	12	А
V <sub>FR</sub>	forward recovery voltage	$I_F = 20 \text{ A}; \text{ d}I_F/\text{d}t = 100 \text{ A}/\mu\text{s}; \text{ see } \frac{\text{Figure 4}}{100 \text{ A}}$	-	8	11	V

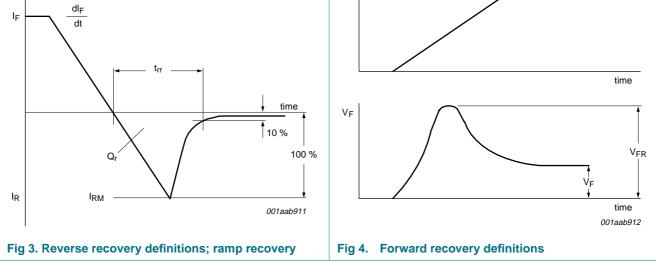
## Table 6. Characteristics

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#### Rectifier diode, hyperfast

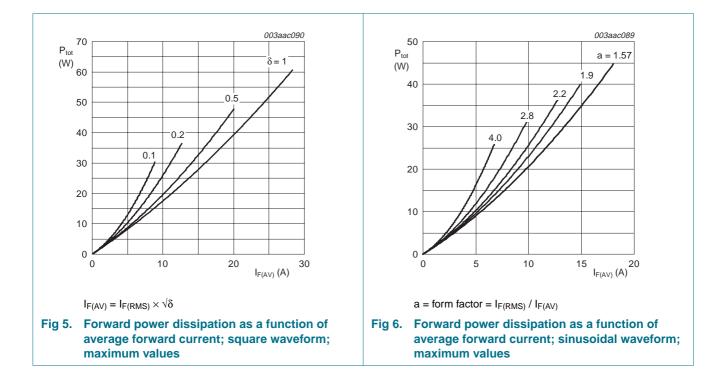




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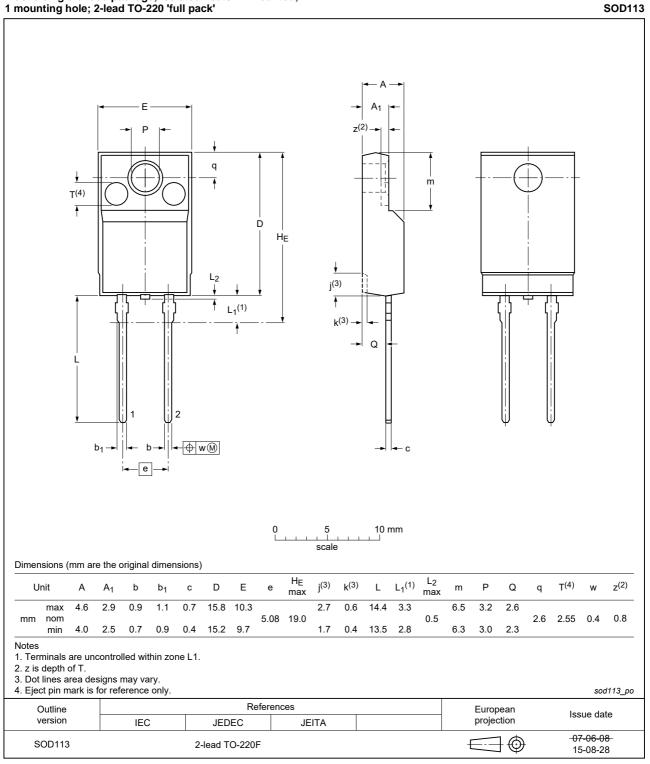
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#### **Package outline** 8.

Plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 2-lead TO-220 'full pack'



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# BYC20X-600

#### Rectifier diode, hyperfast

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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